



DECLARATION - USA PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **COLLAGEN-BASED BIOMATERIAL FOR TISSUE REPAIR**, the specification of which was filed on July 10, 2003 as Application No. 10/618,447;

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, §§ 119 or 365 of any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) listed below and have also identified below any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed for the same subject matter having a filing date before that of the application(s) of which priority is claimed:

PRIOR FOREIGN APPLICATIONS

COUNTRY	APPLICATION NUMBER	DATE OF FILING	PRIORITY CLAIMED UNDER 37 U.S.C. § 119(b)
Korea	2001/54489	September 5, 2001	Yes
Korea	2001/56337	September 13, 2001	Yes

I hereby claim the benefit under Title 35, United States Code, §§ 120 or 365 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

PRIOR U.S.A. APPLICATION

APPLICATION NUMBER	DATE OF FILING	PRIORITY CLAIMED UNDER 37 U.S.C. § 365(c)
PCT/KR02/01679	September 5, 2002	Yes

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: KIM, Tae-Woon

Dated: Nov. 5, 2003 Inventor's signature TAE WOON KIM
Residence : 233-301 Banpojugong Apartment, 18-1 Banpo 2-dong, Seocho-gu
Seoul 137-764, Republic of Korea

Post Office Address: Same as Residence.

Full name of second inventor: PARK, Sung-Young

Dated: Nov. 5, 2003 Inventor's signature Sung Young Park
Residence: 107-103 Hansoop Apartment, Yongjeon-dong, Dong-gu, Taejon 300-768
Republic of Korea
Post Office Address: Same as Residence

Full name of third inventor: Hwang, Ho-Chan

Dated: Nov. 5, 2003 Inventor's signature Ho Chan Hwang
Residence: 4-2702 Hyundai Apartment, 631-1 Gooeui-dong, Kwangjin-gu, Seoul 143-200
Republic of Korea

Post Office Address: Same as Residence

Send Correspondence To:
KNOBBE, MARTENS, OLSON & BEAR, LLP
Customer No. 20,995

LEELE82.001C1



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants	:	Kim, et al.)
)
App. No.	:	10/618,447)
)
Filed	:	July 10, 2003)
)
For	:	COLLAGEN-BASED BIOMATERIAL FOR TISSUE REPAIR)
)
Examiner	:	Unknown)

ESTABLISHMENT OF RIGHT OF ASSIGNEE TO TAKE ACTION
AND
REVOCATION AND POWER OF ATTORNEY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The undersigned is empowered to act on behalf of the assignee below (the "Assignee"). A true copy of the original Assignment of the above-captioned application from the inventors to the Assignee is attached hereto. This Assignment represents the entire chain of title of this invention from the Inventors to the Assignee.

I declare that all statements made herein are true, and that all statements made upon information and belief are believed to be true, and further, that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that willful, false statements may jeopardize the validity of the application, or any patent issuing thereon.

The undersigned hereby revokes any previous powers of attorney in the subject application, and hereby appoints the registrants of Knobbe, Martens, Olson & Bear, LLP, 2040 Main Street, Fourteenth Floor, Irvine, California 92614, Telephone (949) 760-0404, Customer No. 20,995, as its attorneys with full power of substitution and revocation to prosecute this

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Filed : July 10, 2003

application and to transact all business in the U.S. Patent and Trademark Office connected herewith. This appointment is to be to the exclusion of the inventor(s) and his attorney(s) in accordance with the provisions of 37 C.F.R. § 3.71.

Please use **Customer No. 20,995** for all communications.

HANS BIOMED CORPORATION

Dated: Nov. 6, 2003

Signature: Ho Chan Hwang

Name: Hwang, Ho-Chan

Title: Representative

Address: **16-4, Seongsu-dong 1-ga**
Seongdong-gu, Seoul 133-110
Republic of Korea

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Filing Date: July 10, 2003

Client Code: LEELE82.001C1
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ASSIGNMENT

WHEREAS, we, the undersigned, have invented certain new and useful improvements in a entitled **COLLAGEN-BASED BIOMATERIAL FOR TISSUE REPAIR**, for which we have filed an application for Letter Patent in the United States as Application No. 10/618,447 on July 10, 2003.

AND WHEREAS, Hans Biomed Corporation., (hereinafter "ASSIGNEE"), with its principal place of business at **16-4, Seongsu-dong 1-ga, Seongdong-gu, Seoul 133-110, Republic of Korea**, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest throughout the world in, to and under the said improvements, and the said applications and provisional applications relating thereto, and all divisions, renewals and continuations thereof, and ~~all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.~~

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date: Nov. 5, 2003

Signature: TAE WOON KIM

Name: KIM, Tae-Woon

Address : **233-301 Banpojugong Apartment, 18-1
Banpo 2-dong, Seocho-gu
Seoul 137-764, Republic of Korea**

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Date: Nov. 5, 2003

Signature: Sung Young Park

Name: PARK, Sung-Young

Address : 107-103 Hansoop Apartment
Yongjeon-dong, Dong-gu
Taejon 300-768, Republic of Korea

Date: Nov. 5. 2003

Signature: Ho Chan Hwang

Name: HWANG, Ho-Chan

Address : 4-2702 Hyundae Apartment
631-1 Gooeui-dong, Kwangjin-gu
Seoul 143-200, Republic of Korea